

Absolute Maximum Ratings — Standard Triac

| Symbol | Parameter | Value | Unit |
|--------------|--|--|-----------------------|
| $I_{T(RMS)}$ | RMS on-state current (full sine wave) | $Qxx15Ly$ | $T_c = 80^\circ C$ |
| | | $Qxx15Ry$ $Qxx15Ny$ | $T_c = 90^\circ C$ |
| I_{TSM} | Non repetitive surge peak on-state current (full cycle, T_j initial = $25^\circ C$) | $f = 50$ Hz | $t = 20$ ms |
| | | $f = 60$ Hz | $t = 16.7$ ms |
| I^2t | I^2t Value for fusing | $t_p = 8.3$ ms | 166 A^2s |
| di/dt | Critical rate of rise of on-state current | $f = 120$ Hz | $T_j = 125^\circ C$ |
| I_{GTM} | Peak gate trigger current | $t_p \leq 10$ μs $I_{GT} \leq I_{GTM}$ | $T_j = 125^\circ C$ |
| $P_{G(AV)}$ | Average gate power dissipation | $T_j = 125^\circ C$ | 0.5 W |
| T_{stg} | Storage temperature range | | -40 to 150 $^\circ C$ |
| T_j | Operating junction temperature range | | -40 to 125 $^\circ C$ |

Note: xx = voltage, y = sensitivity

Absolute Maximum Ratings — Alternistor Triac (3 Quadrants)

| Symbol | Parameter | Value | Unit |
|--------------|--|--|-----------------------|
| $I_{T(RMS)}$ | RMS on-state current (full sine wave) | $Qxx16LHy$ | $T_c = 80^\circ C$ |
| | | $Qxx16RHy$ $Qxx16NHy$ | $T_c = 90^\circ C$ |
| I_{TSM} | Non repetitive surge peak on-state current (full cycle, T_j initial = $25^\circ C$) | $f = 50$ Hz | $t = 20$ ms |
| | | $f = 60$ Hz | $t = 16.7$ ms |
| I^2t | I^2t Value for fusing | $t_p = 8.3$ ms | 166 A^2s |
| di/dt | Critical rate of rise of on-state current | $f = 120$ Hz | $T_j = 125^\circ C$ |
| I_{GTM} | Peak gate trigger current | $t_p \leq 10$ μs $I_{GT} \leq I_{GTM}$ | $T_j = 125^\circ C$ |
| $P_{G(AV)}$ | Average gate power dissipation | $T_j = 125^\circ C$ | 0.5 W |
| T_{stg} | Storage temperature range | | -40 to 150 $^\circ C$ |
| T_j | Operating junction temperature range | | -40 to 125 $^\circ C$ |

Note: xx = voltage, y = sensitivity

Electrical Characteristics ($T_j = 25^\circ C$, unless otherwise specified) — Standard Triac

| Symbol | Test Conditions | Quadrant | | Value | Unit |
|--------------|---|----------------|------|-------|-----------|
| I_{GT} | $V_D = 12V$ $R_L = 60 \Omega$ | $I - II - III$ | MAX. | 50 | mA |
| V_{GT} | | $I - II - III$ | MAX. | 2.0 | V |
| V_{GD} | $V_D = V_{DRM}$ $R_L = 3.3 k\Omega$ $T_j = 125^\circ C$ | | MIN. | 0.2 | V |
| I_H | $I_T = 100mA$ | | MAX. | 70 | mA |
| dv/dt | $V_D = V_{DRM}$ Gate Open $T_j = 125^\circ C$ | 400V | MIN. | 275 | $V/\mu s$ |
| | | 600V | | 225 | |
| | | 800V | | 200 | |
| | $V_D = V_{DRM}$ Gate Open $T_j = 100^\circ C$ | 1000V | | 200 | |
| (dv/dt)c | $(di/dt)c = 8.1 A/ms$ $T_j = 125^\circ C$ | | MIN. | 4 | $V/\mu s$ |
| t_{gt} | $I_G = 2 \times I_{GT}$ $PW = 15\mu s$ $I_T = 22.6 A(pk)$ | | TYP. | 4 | μs |

Electrical Characteristics ($T_j = 25^\circ\text{C}$, unless otherwise specified) — Alternistor Triac (3 Quadrants)

| Symbol | Test Conditions | Quadrant | | Qxx16xH2 | Qxx16xH3 | Qxx16xH4 | Qxx16xH6 | Unit |
|--------------|---|----------|--------------|----------|----------|----------|----------|---------------|
| I_{GT} | $V_D = 12\text{V}$ $R_L = 60\ \Omega$ | | I - II - III | MAX. | 10 | 20 | 35 | 80 |
| V_{GT} | | | I - II - III | MAX. | 1.3 | | | V |
| V_{GD} | $V_D = V_{DRM}$ $R_L = 3.3\ \text{k}\Omega$ $T_j = 125^\circ\text{C}$ | | I - II - III | MIN. | 0.2 | | | V |
| I_H | $I_T = 100\text{mA}$ | | | MAX. | 15 | 35 | 50 | 70 |
| dv/dt | $V_D = V_{DRM}$ Gate Open $T_j = 125^\circ\text{C}$ | | 400V | MIN. | 200 | 350 | 475 | 925 |
| | | | 600V | | 150 | 250 | 400 | 850 |
| | | | 800V | | 100 | 200 | 350 | 475 |
| | $V_D = V_{DRM}$ Gate Open $T_j = 100^\circ\text{C}$ | | 1000V | | 100 | 200 | 300 | 350 |
| (dv/dt)c | $(di/dt)c = 8.6\ \text{A}/\text{ms}$ $T_j = 125^\circ\text{C}$ | | | MIN. | 2 | 20 | 25 | 30 |
| t_{gt} | $I_G = 2 \times I_{GT}$ PW = 15 μs $I_T = 22.6\ \text{A}(\text{pk})$ | | | TYP. | 3 | 3 | 3 | 5 |
| | | | | | | | | μs |

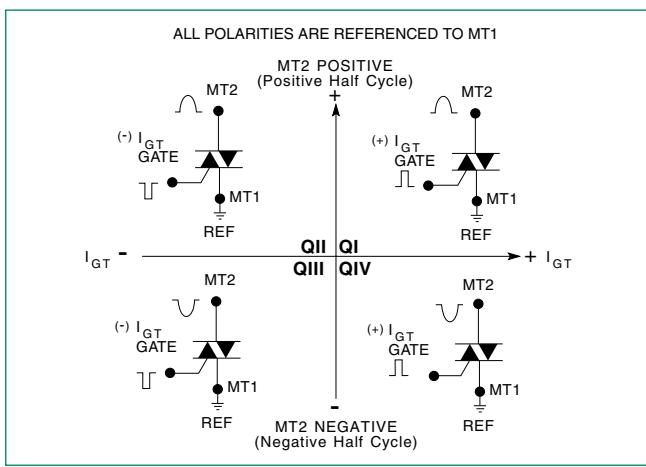
Static Characteristics

| Symbol | Test Conditions | | Value | Unit |
|-----------|--|---------------------------|-----------|-----------------|
| V_{TM} | 15A Device $I_T = 21.2\text{A}$ $t_p = 380\mu\text{s}$ | MAX | 1.60 | V |
| | 16A Device $I_T = 22.6\text{A}$ $t_p = 380\mu\text{s}$ | | | |
| I_{DRM} | $V_D = V_{DRM} / V_{RRM}$ | $T_j = 25^\circ\text{C}$ | 400-1000V | 5 μA |
| I_{RRM} | | $T_j = 125^\circ\text{C}$ | 400-800V | 2 mA |
| | | $T_j = 100^\circ\text{C}$ | 1000V | 3 |

Thermal Resistances

| Symbol | Parameter | | Value | Unit |
|-------------------|-----------------------|---------------------------------|----------|---------------------------|
| $R_{\theta(J-C)}$ | Junction to case (AC) | Qxx15Ry | 1.7 | $^\circ\text{C}/\text{W}$ |
| | | Qxx15Ny Qxx16RHy Qxx16NHy | | |
| $R_{\theta(J-A)}$ | Junction to ambient | Qxx15Ly Qxx16LHy | 2.1 | $^\circ\text{C}/\text{W}$ |
| | | Qxx15Ry Qxx16RHy | | |
| | | Qxx15Ly Qxx16LHy | 45 50 | |

Note: xx = voltage; y = sensitivity

Figure 1: Definition of Quadrants


Note: Alternistors will not operate in QIV

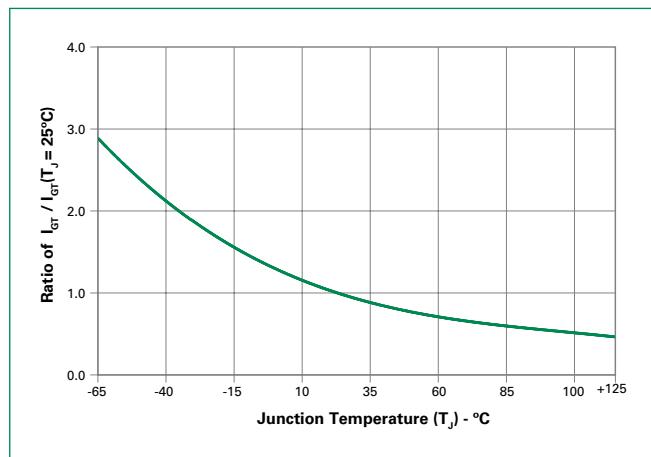
Figure 2: Normalized DC Gate Trigger Current for All Quadrants vs. Junction Temperature


Figure 3: Normalized DC Holding Current vs. Junction Temperature

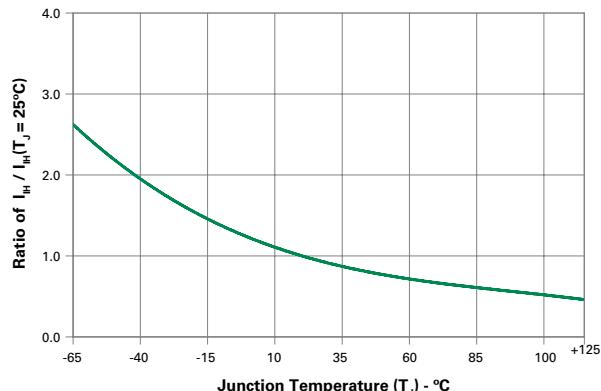


Figure 4: Normalized DC Gate Trigger Voltage for All Quadrants vs. Junction Temperature

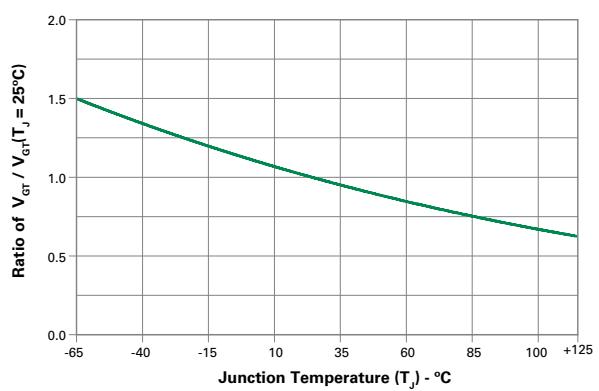


Figure 5: Power Dissipation (Typical) vs. RMS On-State Current

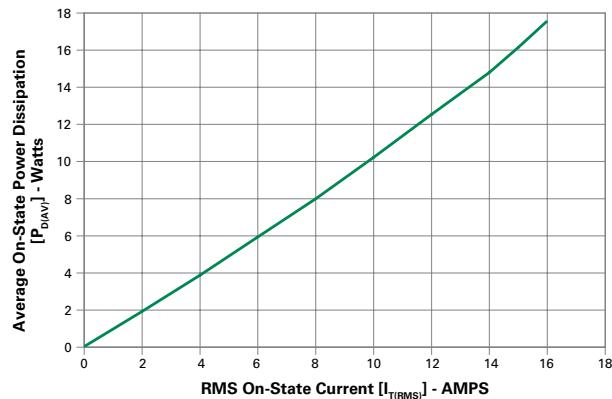


Figure 6: Maximum Allowable Case Temperature vs. On-State Current (15A devices)

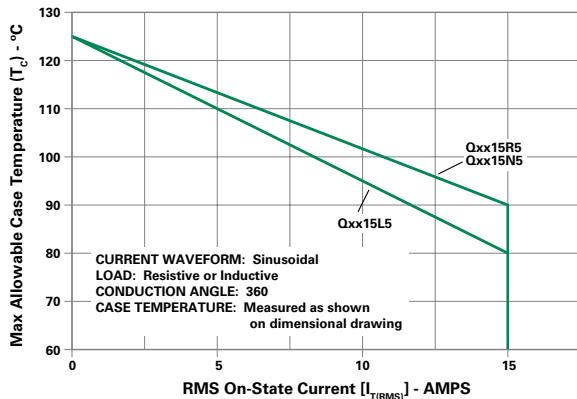


Figure 7: Maximum Allowable Case Temperature vs. On-State Current (16A devices)

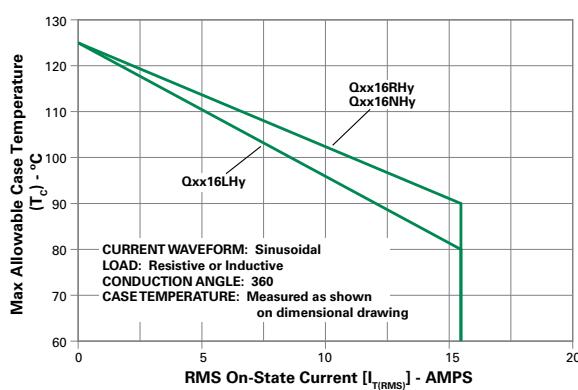


Figure 8: Maximum Allowable Ambient Temperature vs. On-State Current

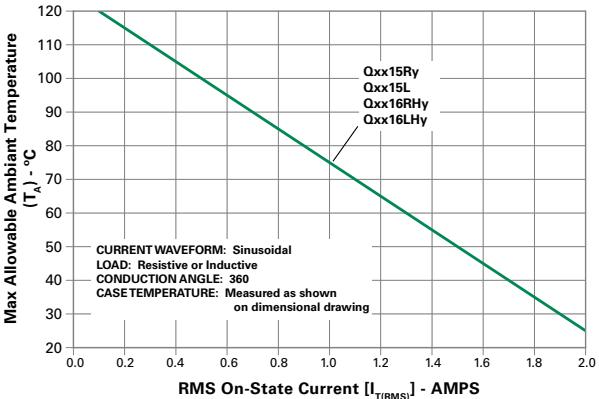
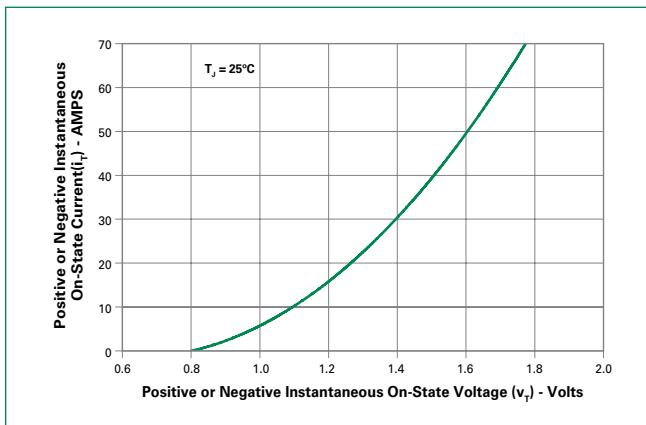
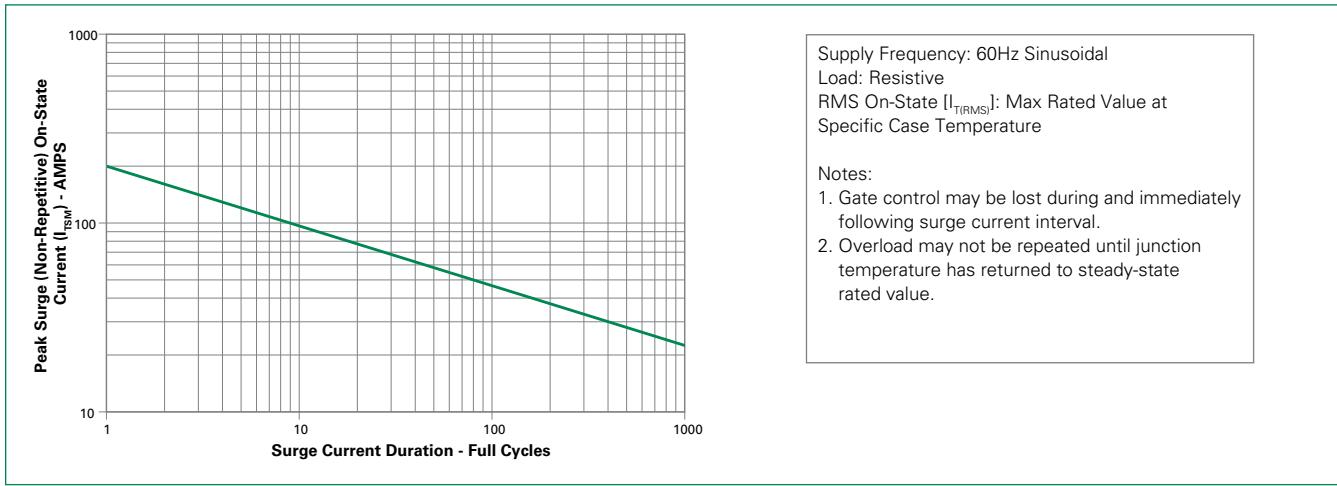
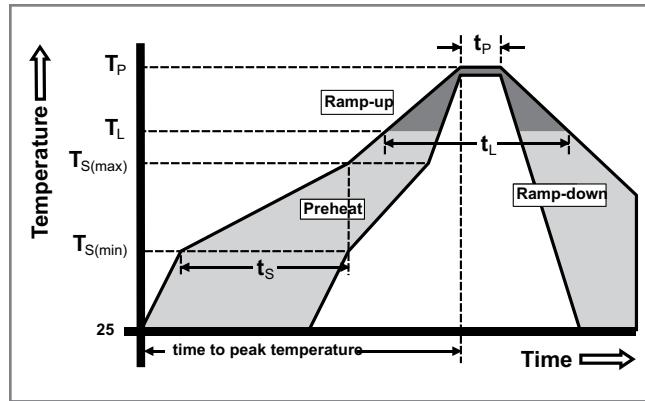


Figure 9: On-State Current vs. On-State Voltage (Typical)

Figure 10: Surge Peak On-State Current vs. Number of Cycles


Soldering Parameters

| Reflow Condition | | Pb – Free assembly |
|--|--------------------------------------|-------------------------|
| Pre Heat | - Temperature Min ($T_{S(min)}$) | 150°C |
| | - Temperature Max ($T_{S(max)}$) | 200°C |
| | - Time (min to max) (t_s) | 60 – 180 secs |
| Average ramp up rate (Liquidus Temp) (T_L) to peak | | 5°C/second max |
| Reflow | $T_{S(max)}$ to T_L - Ramp-up Rate | 5°C/second max |
| | - Temperature (T_L) (Liquidus) | 217°C |
| | - Temperature (t_L) | 60 – 150 seconds |
| | Peak Temperature (T_p) | 260 ^{+0/-5} °C |
| Time within 5°C of actual peak Temperature (t_p) | | 20 – 40 seconds |
| Ramp-down Rate | | 5°C/second max |
| Time 25°C to peak Temperature (T_p) | | 8 minutes Max. |
| Do not exceed | | 280°C |



Physical Specifications

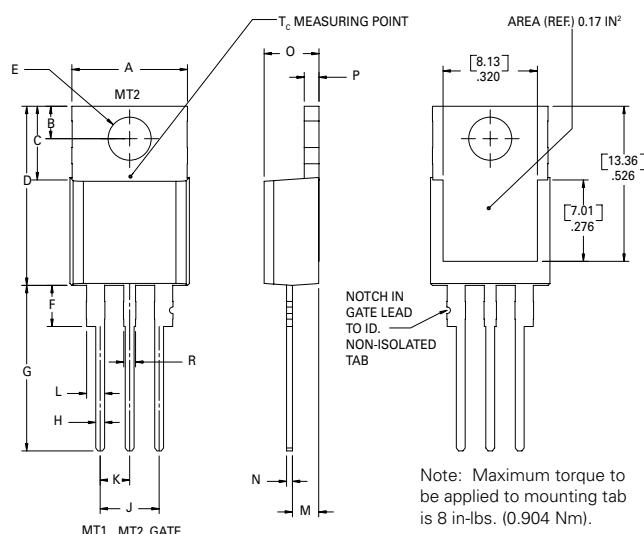
| | |
|--------------------------|---|
| Terminal Finish | 100% Matte Tin-plated |
| Body Material | UL recognized epoxy meeting flammability classification 94V-0 |
| Terminal Material | Copper Alloy |

Design Considerations

Careful selection of the correct device for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the device rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

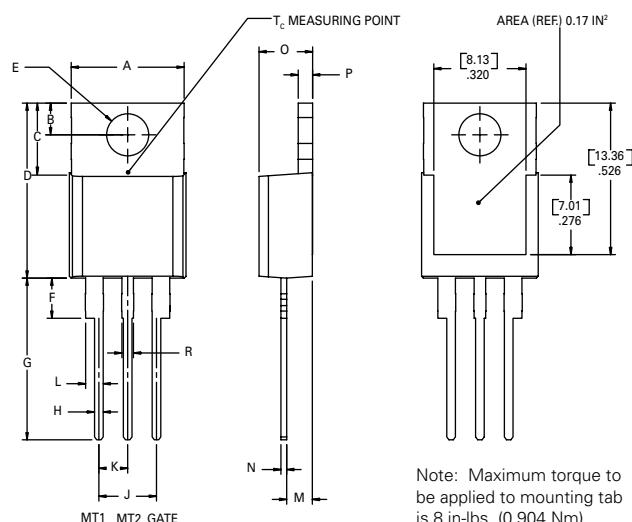
Environmental Specifications

| Test | Specifications and Conditions |
|----------------------------------|---|
| AC Blocking | MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours |
| Temperature Cycling | MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell time |
| Temperature/Humidity | EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity |
| High Temp Storage | MIL-STD-750, M-1031, 1008 hours; 150°C |
| Low-Temp Storage | 1008 hours; -40°C |
| Thermal Shock | MIL-STD-750, M-1056 10 cycles; 0°C to 100°C; 5-min dwell time at each temperature; 10 sec (max) transfer time between temperature |
| Autoclave | EIA / JEDEC, JESD22-A102 168 hours (121°C at 2 ATMs) and 100% R/H |
| Resistance to Solder Heat | MIL-STD-750 Method 2031 |
| Solderability | ANSI/J-STD-002, category 3, Test A |
| Lead Bend | MIL-STD-750, M-2036 Cond E |

Dimensions – TO-220AB (R-Package) – Non-Isolated Mounting Tab Common with Center Lead

| Dimension | Inches | | Millimeters | |
|-----------|--------|-------|-------------|-------|
| | Min | Max | Min | Max |
| A | 0.380 | 0.420 | 9.65 | 10.67 |
| B | 0.105 | 0.115 | 2.66 | 2.92 |
| C | 0.230 | 0.250 | 5.84 | 6.35 |
| D | 0.590 | 0.620 | 14.99 | 15.75 |
| E | 0.142 | 0.147 | 3.61 | 3.73 |
| F | 0.110 | 0.130 | 2.79 | 3.30 |
| G | 0.540 | 0.575 | 13.72 | 14.61 |
| H | 0.025 | 0.035 | 0.64 | 0.89 |
| J | 0.195 | 0.205 | 4.95 | 5.21 |
| K | 0.095 | 0.105 | 2.41 | 2.67 |
| L | 0.060 | 0.075 | 1.52 | 1.91 |
| M | 0.085 | 0.095 | 2.16 | 2.41 |
| N | 0.018 | 0.024 | 0.46 | 0.61 |
| O | 0.178 | 0.188 | 4.52 | 4.78 |
| P | 0.045 | 0.060 | 1.14 | 1.52 |
| R | 0.038 | 0.048 | 0.97 | 1.22 |

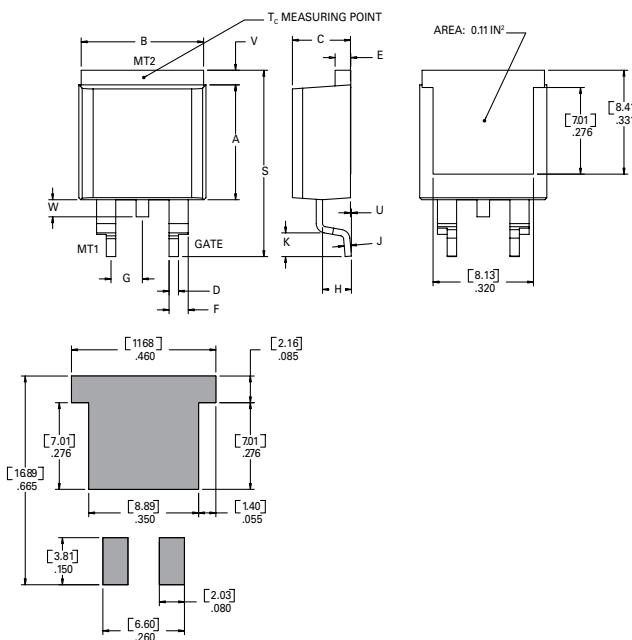
Dimensions — TO-220AB (L-Package) — Isolated Mounting Tab



Note: Maximum torque to be applied to mounting tab is 8 in-lbs. (0.904 Nm).

| Dimension | Inches | | Millimeters | |
|-----------|--------|-------|-------------|-------|
| | Min | Max | Min | Max |
| A | 0.380 | 0.420 | 9.65 | 10.67 |
| B | 0.105 | 0.115 | 2.67 | 2.92 |
| C | 0.230 | 0.250 | 5.84 | 6.35 |
| D | 0.590 | 0.620 | 14.99 | 15.75 |
| E | 0.142 | 0.147 | 3.61 | 3.73 |
| F | 0.110 | 0.130 | 2.79 | 3.30 |
| G | 0.540 | 0.575 | 13.72 | 14.60 |
| H | 0.025 | 0.035 | 0.64 | 0.89 |
| J | 0.195 | 0.205 | 4.95 | 5.21 |
| K | 0.095 | 0.105 | 2.41 | 2.67 |
| L | 0.060 | 0.075 | 1.52 | 1.91 |
| M | 0.085 | 0.095 | 2.16 | 2.41 |
| N | 0.018 | 0.024 | 0.46 | 0.61 |
| O | 0.178 | 0.188 | 4.52 | 4.78 |
| P | 0.045 | 0.060 | 1.14 | 1.52 |
| R | 0.038 | 0.048 | 0.97 | 1.22 |

Dimensions — TO-263AB (N-Package) — D²Pak Surface Mount



| Dimension | Inches | | Millimeters | |
|-----------|--------|-------|-------------|-------|
| | Min | Max | Min | Max |
| A | 0.360 | 0.370 | 9.14 | 9.40 |
| B | 0.380 | 0.420 | 9.65 | 10.67 |
| C | 0.178 | 0.188 | 4.52 | 4.78 |
| D | 0.025 | 0.035 | 0.64 | 0.89 |
| E | 0.045 | 0.060 | 1.14 | 1.52 |
| F | 0.060 | 0.075 | 1.52 | 1.91 |
| G | 0.095 | 0.105 | 2.41 | 2.67 |
| H | 0.092 | 0.102 | 2.34 | 2.59 |
| J | 0.018 | 0.024 | 0.46 | 0.61 |
| K | 0.090 | 0.110 | 2.29 | 2.79 |
| S | 0.590 | 0.625 | 14.99 | 15.88 |
| V | 0.035 | 0.045 | 0.89 | 1.14 |
| U | 0.002 | 0.010 | 0.05 | 0.25 |
| W | 0.040 | 0.070 | 1.02 | 1.78 |

Product Selector

| Part Number | Voltage | | | | Gate Sensitivity Quadrants | Type | Package |
|-------------|---------|------|------|-------|----------------------------|-------------------|----------------------------|
| | 400V | 600V | 800V | 1000V | | | |
| Qxx15L5 | X | X | X | X | 50 mA | Standard Triac | TO-220L |
| Qxx15R5 | X | X | X | X | 50 mA | Standard Triac | TO-220R |
| Qxx15N5 | X | X | X | X | 50 mA | Standard Triac | TO-263 D ² -PAK |
| Qxx16LH2 | X | X | X | X | 10 mA | Alternistor Triac | TO-220L |
| Qxx16RH2 | X | X | X | X | 10 mA | Alternistor Triac | TO-220R |
| Qxx16NH2 | X | X | X | X | 10 mA | Alternistor Triac | TO-263 D ² -PAK |
| Qxx16LH3 | X | X | X | X | 20 mA | Alternistor Triac | TO-220L |
| Qxx16RH3 | X | X | X | X | 20 mA | Alternistor Triac | TO-220R |
| Qxx16NH3 | X | X | X | X | 20 mA | Alternistor Triac | TO-263 D ² -PAK |
| Qxx16LH4 | X | X | X | X | 35 mA | Alternistor Triac | TO-220L |
| Qxx16RH4 | X | X | X | X | 35 mA | Alternistor Triac | TO-220R |
| Qxx16NH4 | X | X | X | X | 35 mA | Alternistor Triac | TO-263 D ² -PAK |
| Qxx16LH6 | X | X | X | X | 80 mA | Alternistor Triac | TO-220L |
| Qxx16RH6 | X | X | X | X | 80 mA | Alternistor Triac | TO-220R |
| Qxx16NH6 | X | X | X | X | 80 mA | Alternistor Triac | TO-263 D ² -PAK |

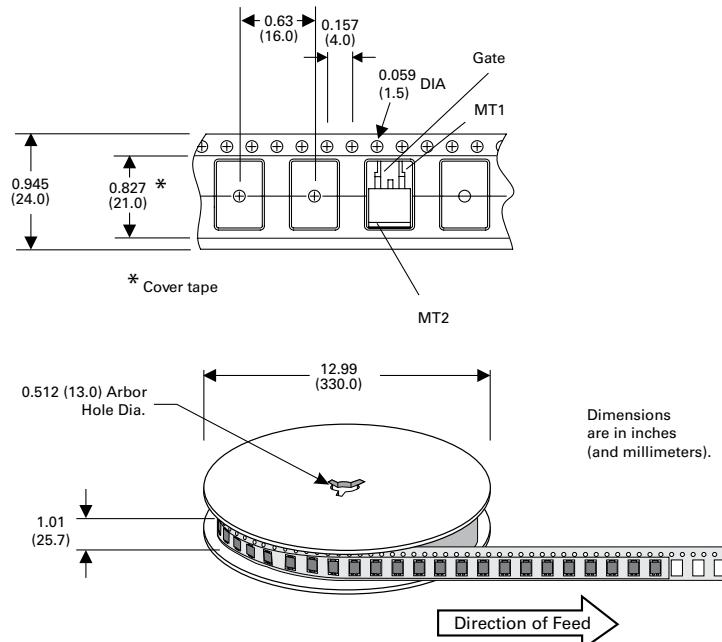
Packing Options

| Part Number | Marking | Weight | Packing Mode | Base Quantity |
|--------------|------------|--------|------------------|-------------------|
| Qxx15L/Ry | Qxx15L/Ry | 2.2 g | Bulk | 500 |
| Qxx15L/RyTP | Qxx15L/Ry | 2.2 g | Tube Pack | 500 (50 per tube) |
| Qxx15NyTP | Qxx15Ny | 1.6 g | Tube | 500 (50 per tube) |
| Qxx15NyRP | Qxx15Ny | 1.6 g | Embossed Carrier | 500 |
| Qxx16L/RHy | Qxx16L/RHy | 2.2 g | Bulk | 500 |
| Qxx16L/RHyTP | Qxx16L/RHy | 2.2 g | Tube Pack | 500 (50 per tube) |
| Qxx16NHyTP | Qxx16NHy | 1.6 g | Tube | 500 (50 per tube) |
| Qxx16NHyRP | Qxx16NHy | 1.6 g | Embossed Carrier | 500 |

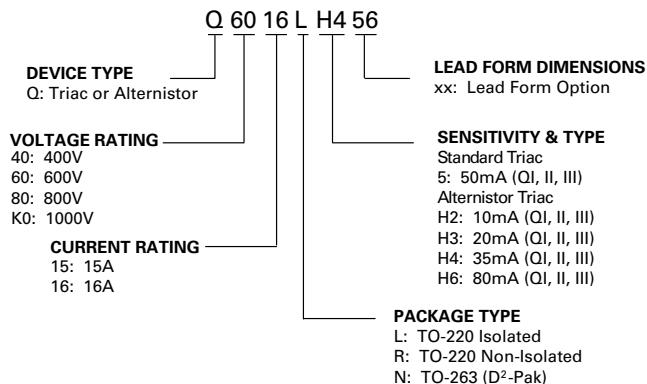
Note: xx = Voltage; y = Sensitivity

TO-263 Embossed Carrier Reel Pack (RP)

Meets all EIA-481-2 Standards

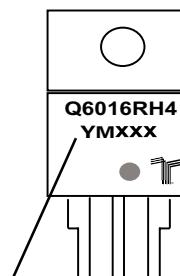


Part Numbering System



Part Marking System

TO-220 AB - (L and R Package)
TO-263 AB - (N Package)



Date Code Marking
Y: Year Code
M: Month Code
XXX: Lot Trace Code